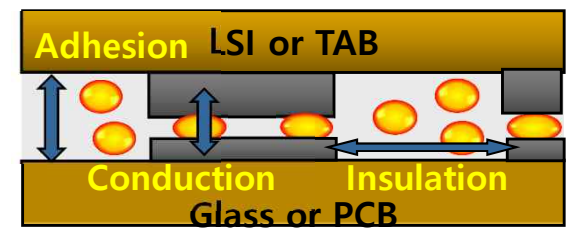
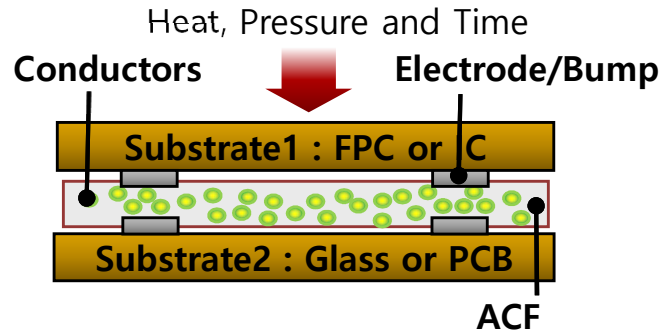


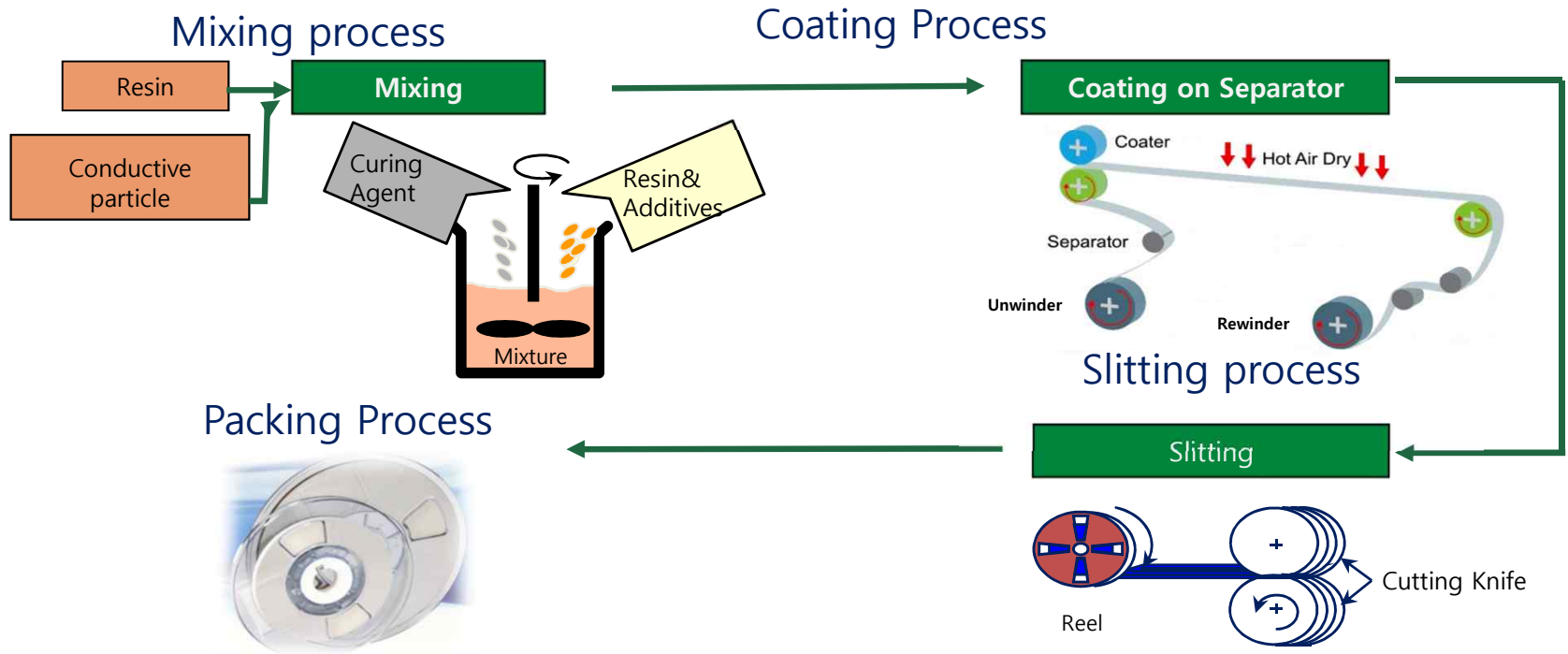
ACF _ principle & manufacturing process

ACF : Anisotropic conductive Film
 Conduction / Insulation / Adhesion

Advantage : Low temperature, Fine Pitch, Short process time,



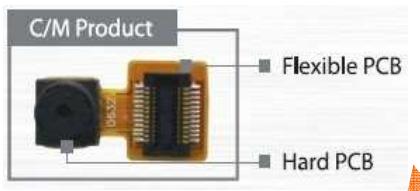
- ◆ Conduction
- ◆ Insulation
- ◆ Adhesion



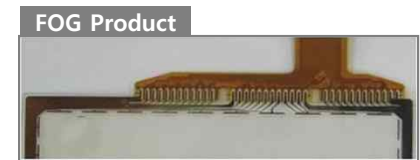
ACF _ Application



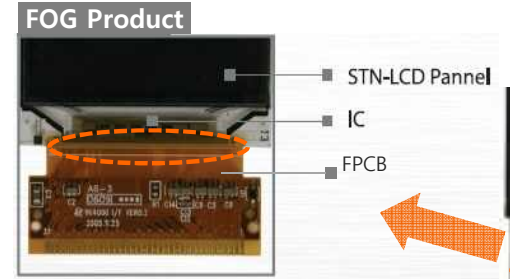
Camera module [CMOS sensor/TCP]



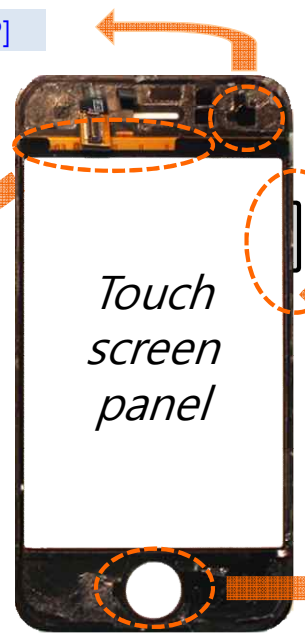
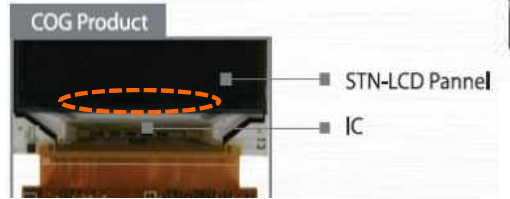
FOF bonding [FPCB / PET]



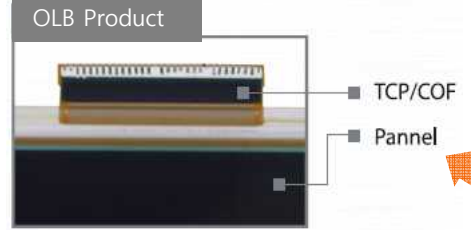
FOG bonding [FPCB / LCD]



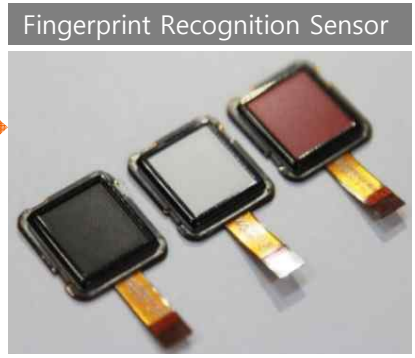
COG bonding [IC / LCD]



TAB bonding_Input [TCP / LCD]



Fingerprint Recognition Sensor [FOB/FOF]



PCB bonding_Output [TCP / PCB]

